

2018-2023 Malaysia Die Bonder Equipment Market Report (Status and Outlook)

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Abstracts

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In 2017, the Die Bonder Equipment market size was xx million USD in Malaysia, and it will be xx million USD in 2023, with a CAGR of xx% between 2017 and 2023.

In Malaysia market, the top players include

Besi

ASM Pacific Technology (ASMPT)

Kulicke & Soffa

Palomar Technologies

Shinkawa

DIAS Automation

Toray Engineering

Panasonic

FASFORD TECHNOLOGY

West-Bond

Hybond

Split by product types/category, covering

Fully Automatic

Semi-Automatic

Manual

Split by applications/end use industries, covers

Integrated Device Manufacturers (IDMs)

Outsourced Semiconductor Assembly and Test (OSAT)

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